



Section _____

MV Semi-conductor

Application _____

Field
Laboratory



PRODUCT BENEFITS

No silicon needed
 Fine tuning of the blade with a 'click' for each 1/10 mm
 Very smooth finish over the insulation
 Adjustable length of semiconductor cutback : 25-30-40 mm / 0,984-1,181-1.575 in

TOOL CAPACITY

Diameter	18 - 60 mm 0,709 - 2,362 inch
Thickness capacity	1,1 mm / 0,043 in
Angle of the chamfer on the semiconductor	8°
Remaining length of the semiconductor	25-30-40 mm / 0,984-1,181-1.575 in

TOOL DIMENSIONS

Length	235 mm
Width	125 mm
Height	90 mm
Weight without box	0,85 Kg
Packaging	Box

Tool to remove bonded semiconductor with chamfer on the semiconductor cutback

TO DO WHAT

The CWB/18-60 enables the user to easily remove the bonded semi-conductor with a chamfer on the transition, leaving a very smooth finish over the insulation
 The CWB 18-60 works without silicone



Options

SGM - Large size pouch

Spare part

LCWB-SP2 - Spare blade for bonded semiconductor with chamfer 8°

Associated tool

- LCWB-FEP - Spare blade for bonded semiconductor with chamfer 13°
- GRI-RTE - Scraper for residues of bonded semiconductor screen with protection pouch
- PG3HTA/2530 - Pliers for MV cables outer sheath
- BRMRD1E - Tool to remove insulation



MV cables Tools

CWB/18-60



Part Number	Diameter	Tool capacity			Dimensions			Packaging
		Thickness capacity	Angle of the chamfer on the semiconductor	Remaining length of the semiconductor	Length	Width	Height	
CWB/18-60	18 - 60 mm 0,709 - 2,362 in	1,1 mm / 0,043 in	8°	25-30-40 mm / 0,984-1,181-1,575 in	235 mm 9,252 in	125 mm 4,921 in	90 mm 3,543 in	box
CWB/18-60-FEP	18 - 60 mm 0,709 - 2,362 in	1,8 mm / 0,071 in	13°	25-30-40 mm / 0,984-1,181-1,575 in	235 mm 9,252 in	125 mm 4,921 in	90 mm 3,543 in	box
CWB/18-60-MVS	18 - 60 mm 0,709 - 2,362 in	1,1 mm / 0,043 in	13 °	With MVS stop	235 mm 9,252 in	125 mm 4,921 in	90 mm 3,543 in	box



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